

AN14399

MCXW71 802.15.4应用的连接性测试

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应用笔记

文档信息

信息	内容
关键词	MCXW71、802.15.4、射频性能、FCC/CE认证
摘要	本应用笔记介绍了使用MCXW71 FRDM开发板通过连接性测试工具进行射频性能测试。



1 简介

本应用笔记介绍了如何使用连接性测试工具来执行MCXW71的802.15.4射频性能测试。

2 测试设置

本节介绍了硬件和软件要求，为测试准备好设置。

2.1 硬件

- 恩智浦的MCXW71 FRDM
- USB Type-C电缆
- 一台安装了串口终端应用程序的个人电脑

使用USB电缆将MCXW71 FRDM的USB端口连接到PC的USB端口，如[图1](#)所示。

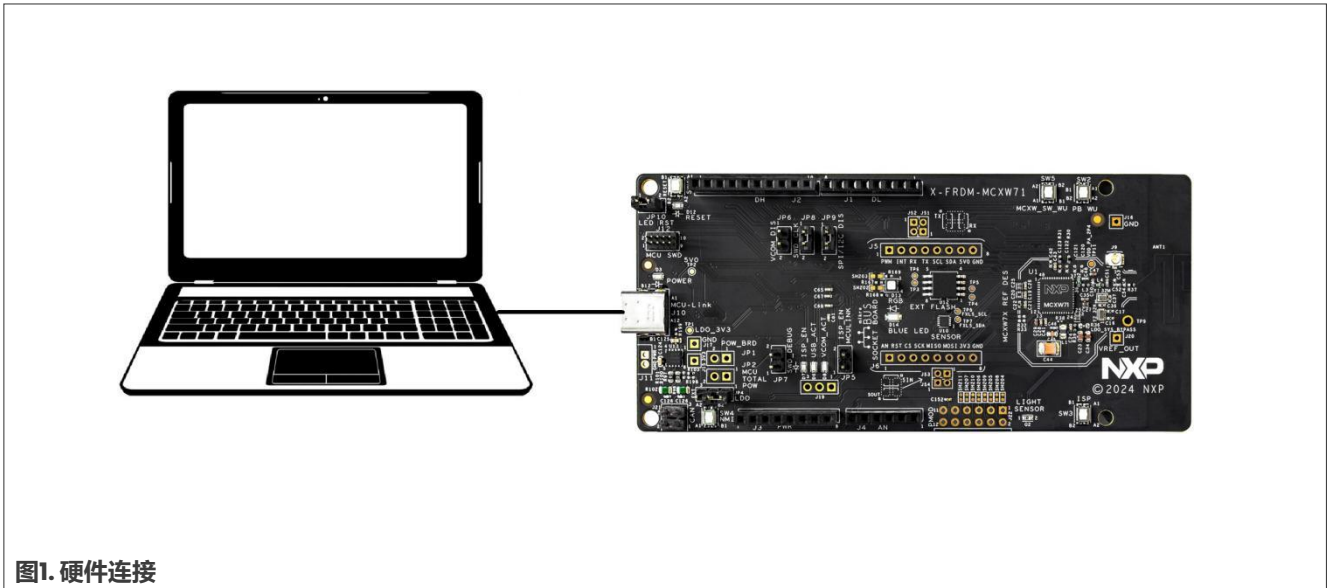


图1. 硬件连接

2.2 软件

- 固件：连接性测试已置于MCXW71 SDK中
- 测试工具：PuTTY或其他终端工具

2.3 测试准备

要执行测试，请按照以下步骤进行：

1. 将固件下载到目标板。
2. 设置COM端口终端。
 - a. 打开计算机上的COM端口终端。
 - b. 选择正确的COM端口设置，波特率为115200。
 - c. 以Putty为例，COM端口设置如[图2](#)所示。

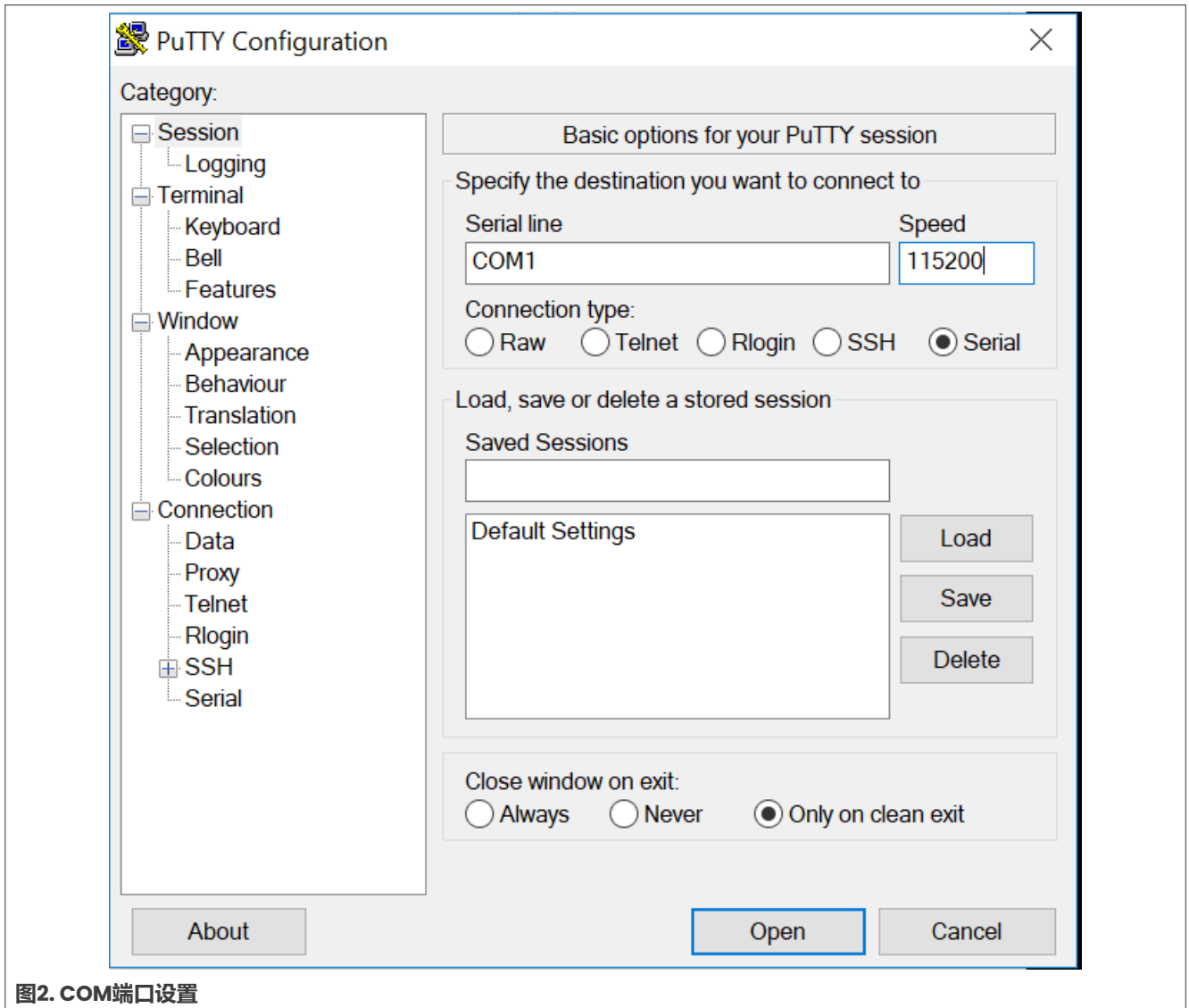


图2. COM端口设置

3 测试项目和选项

该工程使用COM端口终端作为命令控制台来控制MCXW71 FRDM的操作。设置成功完成后，使用正确的设置打开Putty，然后按下复位按钮（SW1）。输出如图3所示。

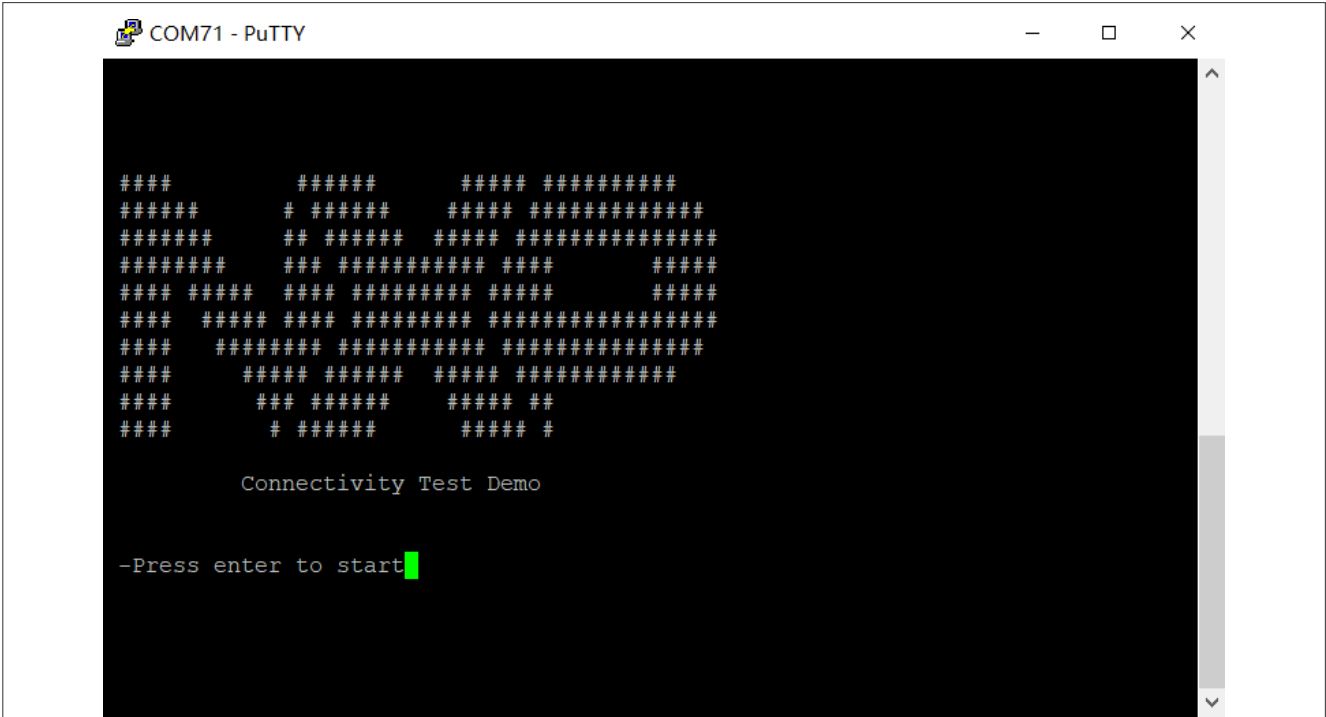


图3. 初始化输出

3.1 测试项目

按下复位按钮 (SW1) 和回车 (Enter) 键后, 包含所有选项和测试项目的主菜单如图4所示。

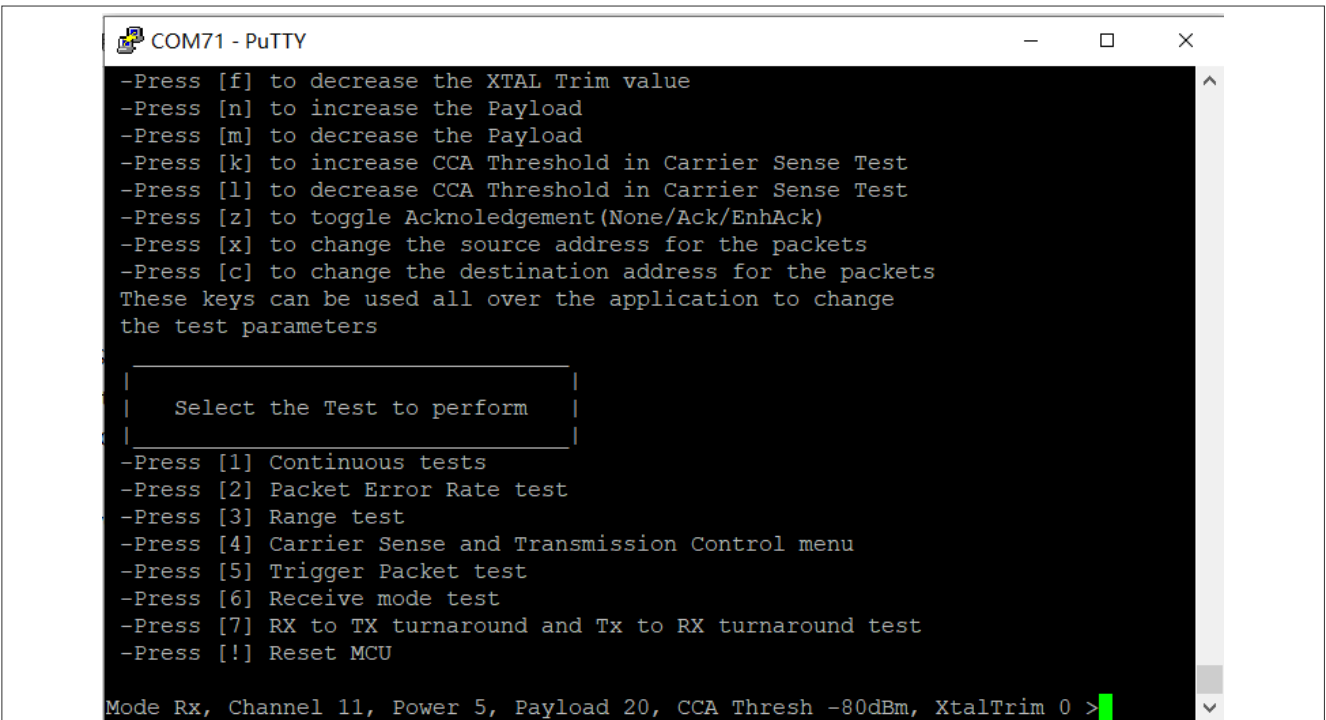


图4. 主菜单

3.2 测试选项

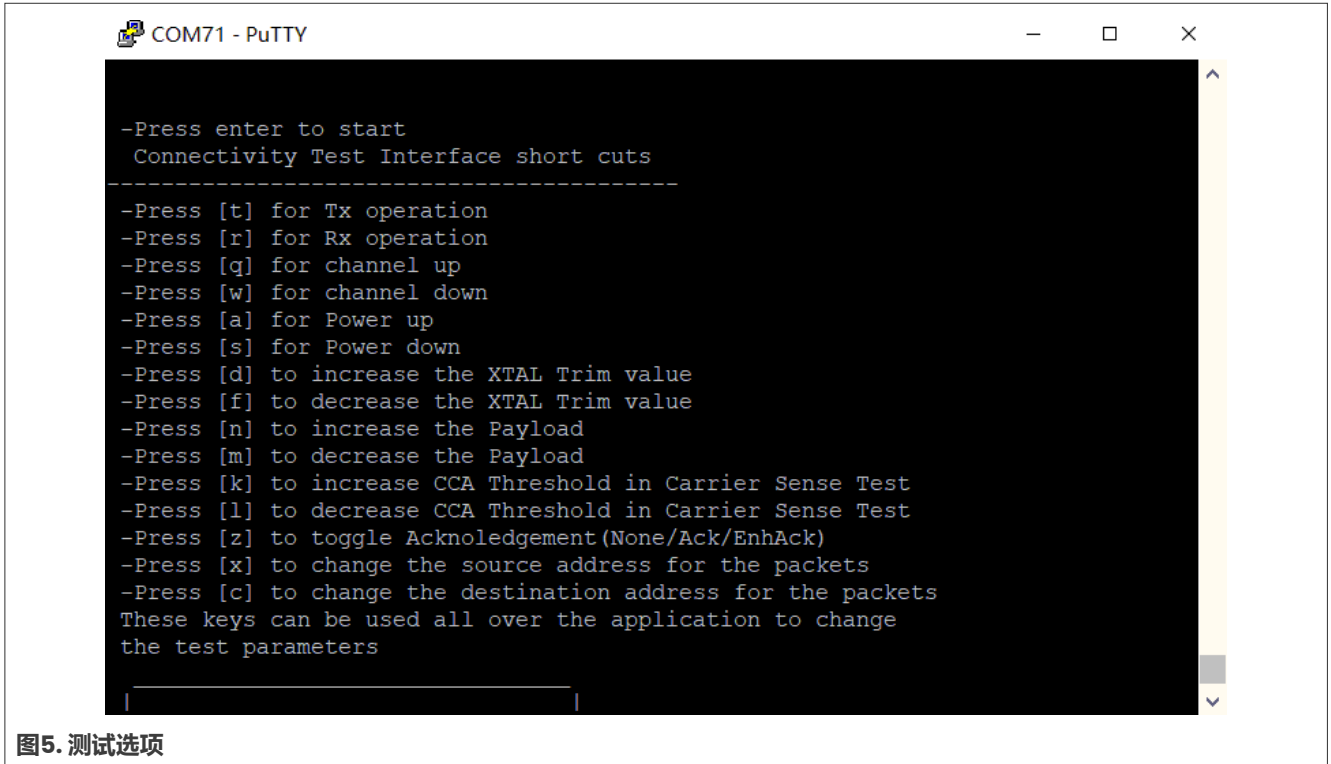


图5. 测试选项

- Tx/Rx模式：
 - 按[t]键进行Tx操作。
 - 按[r]键进行Rx操作。
- 信道更改：
 - 按[q]键切换到更高信道。
 - 按[w]键切换到更低信道。

MCXW71可配置为使用ch11至ch26之间的任何信道频率，每个信道频率间隔为5MHz。这个参数用于从ch11至ch26选择信道号。默认信道为信道11。

表1. 信道

信道	频率 (MHz)
Ch11	2405
Ch12	2410
Ch13	2415
.	.
.	.
Ch18	2440
.	.
.	.
Ch26	2480

- Tx功率：
 - 按[a]键提高功率。

- 按[s]键降低功率。
当功率代码为32时，Tx功率最大为10dBm。
- 设置32MHz晶振调整值：
 - 要增大晶振调整值，请按[d]键。
 - 要减小晶振调整值，请按[f]键。该值的设置范围为0至127。要校准32M时钟的精度，请调整合适的值。
- 设置有效载荷长度：
 - 要增加有效载荷，请按[n]键。
 - 要减少有效载荷，请按[m]键。此参数指定MCXW71需要发送数据包时的有效载荷长度。默认的有效载荷长度为20。此参数在Rx操作时无关紧要。
- CCA阈值
 - 要在载波侦听测试中增加CCA阈值，按[k]键。
 - 要在载波侦听测试中减少CCA阈值，按[l]键。此参数指定CCA阈值。配置范围为0dBm至-110dBm。默认值为-80dBm。
- 切换确认（无/确认/增强确认）：
 - 按[z]键
- 更改数据包的源短地址：
 - 按[x]键此参数指定设备短地址。配置范围为0x0000至0xffff。
- 更改数据包的目的短地址：
 - 按[c]键此参数指定设备短地址。配置范围为0x0000至0xffff。

3.3 测试用例

本节介绍了用于测试的不同测试用例。

3.3.1 连续测试

该测试用例将设备置于连续传输模式或连续接收模式，如图6所示。

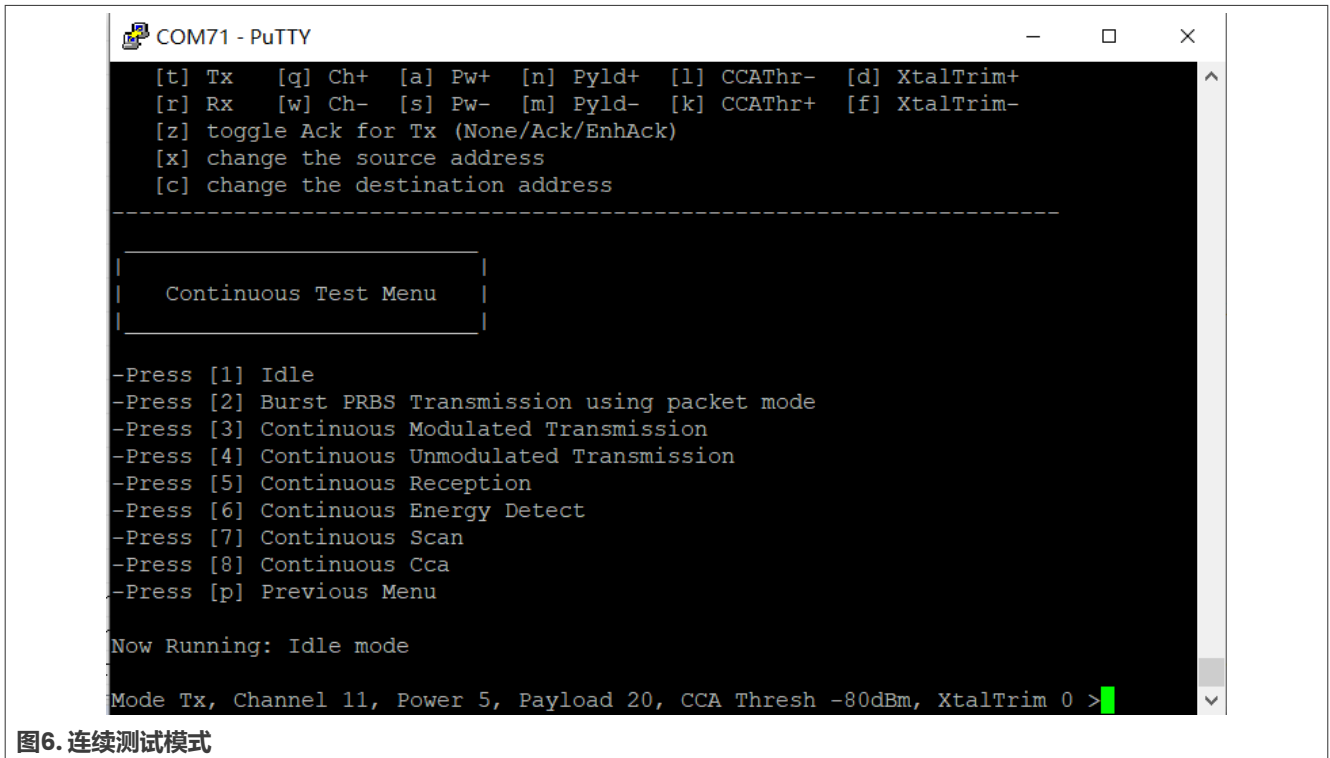


图6. 连续测试模式

- 要选择具有突发PRBS传输的Tx模式，请按[2]键。
- 要选择具有连续调制传输的Tx模式，请按[3]键。
此模式可用于Tx用例测试，例如EVM和Tx输出功率以及一些与FCC、CE和MIIT认证相关的测试用例。
- 要选择具有连续非调制传输的Tx模式，请按[4]键。启用此模式可实现Tx输出信号音调。
- 要选择具有连续接收的Rx模式，请按[5]键。
- 要选择具有能量检测的Rx模式，请按[6]键。
要退出此模式，请按下复位按钮（SW1）。
- 要选择具有信号扫描的Rx模式，请按[7]键。
要退出此模式，请按下复位按钮（SW1）。
- 要选择具有信道CCA的Rx模式，请按[8]键。
要退出此模式，请按下复位按钮（SW1）。

3.3.2 数据包错误率测试

此测试用例允许使用两块运行此模式的开发板来测量数据包错误率。一个设备必须配置为终端设备，另一个配置为协调器，负责控制测试和显示结果，如图7所示。



图7. 数据包错误率测试

- 要选择数据包错误率测试并启用PER测试菜单，请按[2]键。
通过选项[t]和[r]选择Tx或Rx。默认为Rx模式。
 - 协调器的Tx模式：
选择要发送的数据包数量并输入Tx间隔。要启用数据包发送，请按[回车键]。
 - 终端设备的Rx模式：
要开始/停止接收数据包，请按[空格键]。

3.3.3 范围测试

此测试用例允许使用两块运行此模式的开发板来测量范围。一个设备必须配置为终端设备，另一个设备配置为协调器，负责控制测试并显示结果，如图8所示。

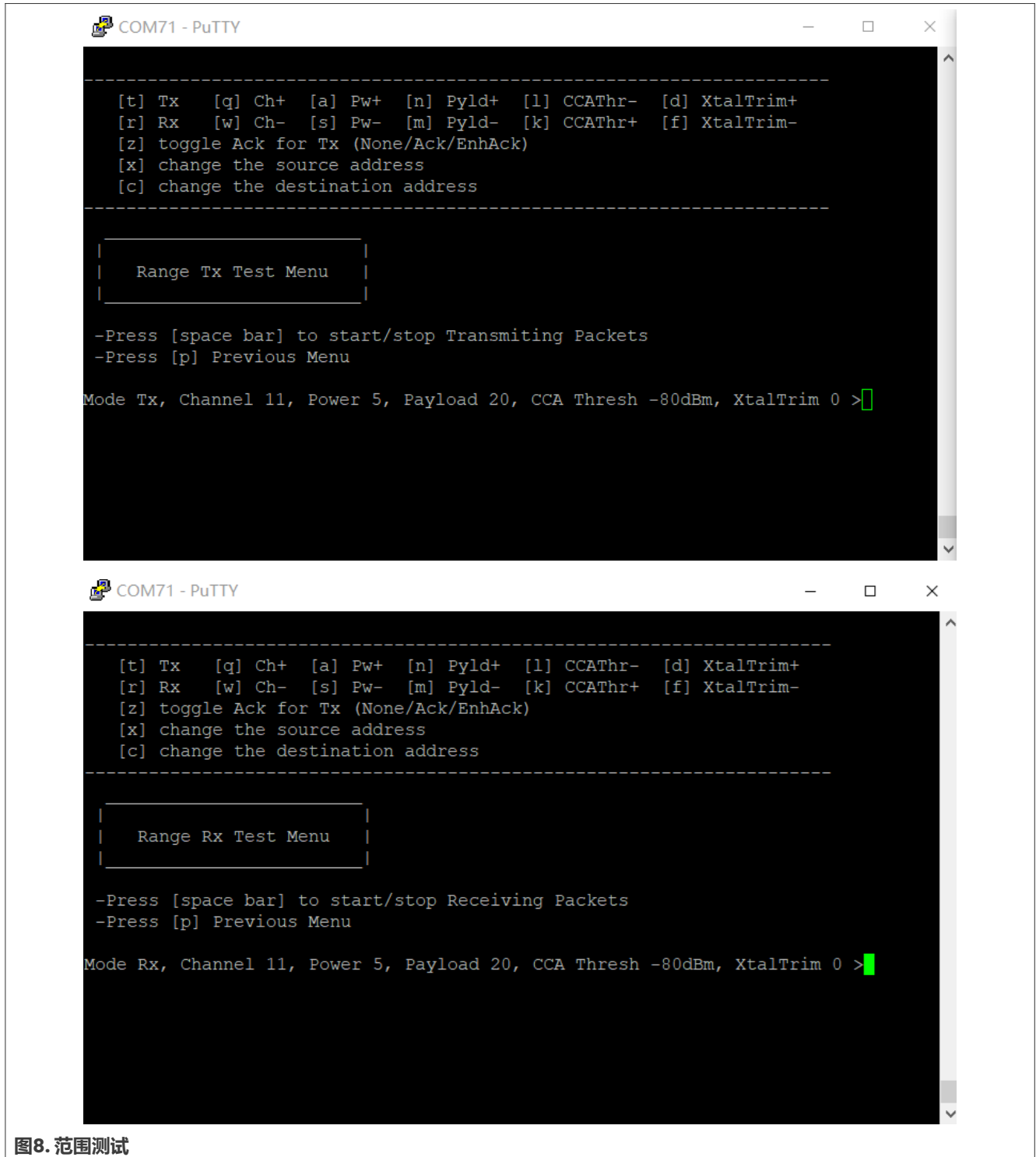


图8. 范围测试

- 要选择范围测试并启用范围测试菜单，请按[3]键。

通过选项[t]和[r]选择Tx或Rx。默认为Rx模式。

- 协调器的Tx模式
 - 要开始/停止发送数据包，请按[空格键]。
- 终端设备的Rx模式
 - 要开始/停止接收数据包，请按[空格键]。

3.3.4 载波侦听和传输控制

如果需要进行一些实验，可调整CCA阈值的载波侦听。

- 要选择载波侦听和传输控制测试并启用测试菜单，请按[4]键。
 - 要选择具有未调制输入信号的载波侦听测试，请按[1]键。
 - 要选择传输控制测试，请按[2]键。

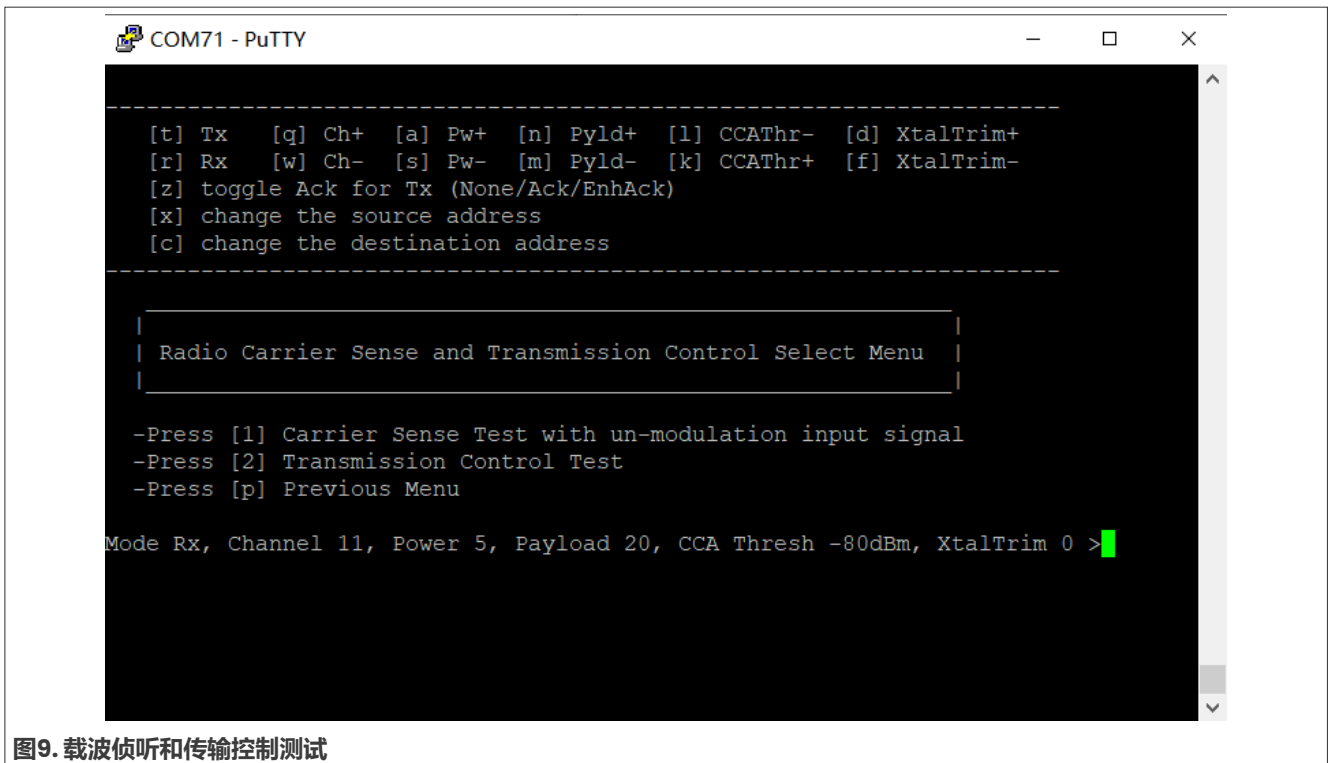


图9. 载波侦听和传输控制测试

3.3.5 触发数据包测试

此测试用例允许测量接收灵敏度，如[图10](#)所示。

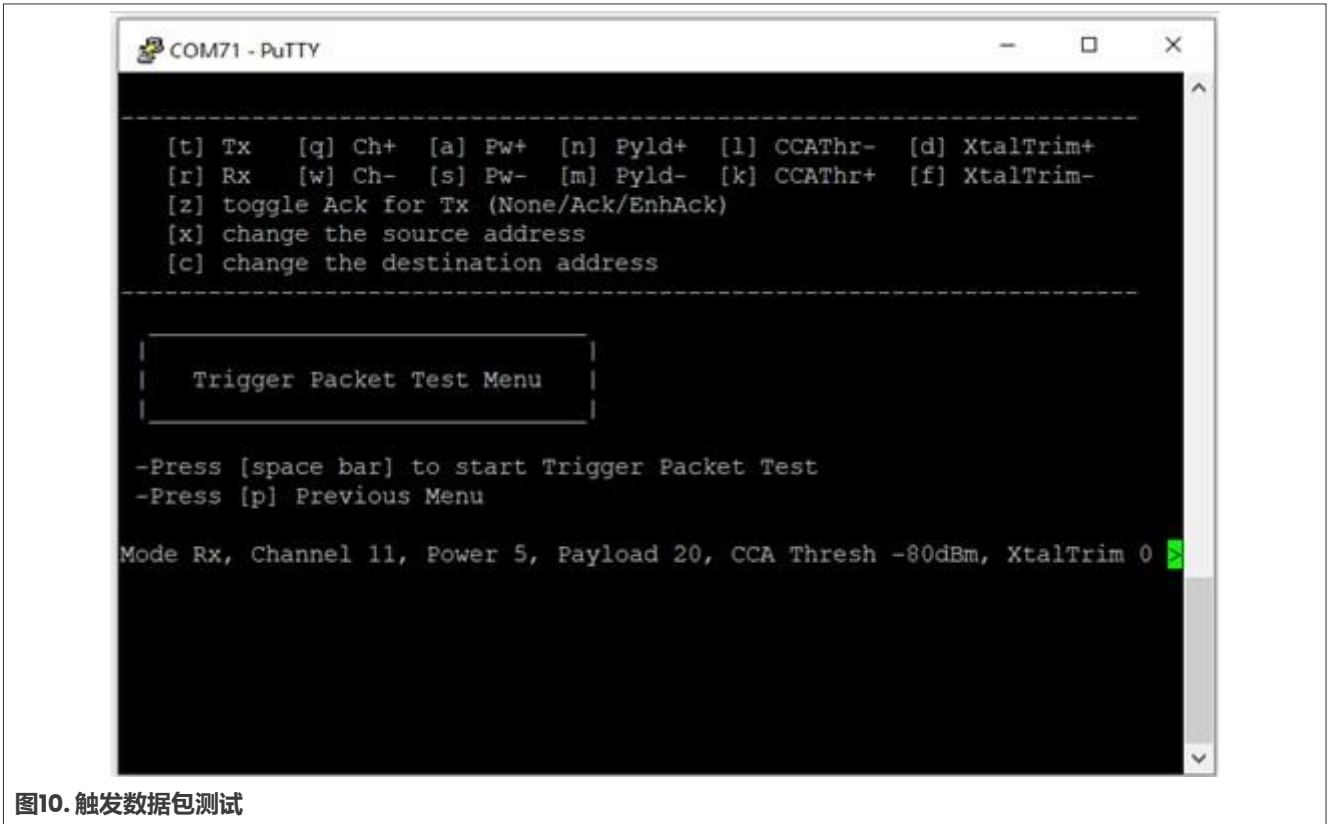


图10. 触发数据包测试

将设备的RFIO端口连接到射频信号发生器，并将设备的一个GPIO连接到射频信号发生器的外部触发输入端。射频信号发生器必须支持任意波形配置，并在每次触发时生成一个理想的数据包。此设备GPIO默认生成1000个触发脉冲。触发次数可通过`connectivity_test.h`中的`#define trigger_cont`进行配置。

信号发生器的外部触发输入必须设置为上升沿模式，且外部延迟约等于2ms。

设备会计数接收到的数据包数量。它还会显示预期的数据包数量和接收到的数据包数量。

携带触发信号的GPIO引脚可以通过配置`connectivity_test.c`中的`BOARD_TRIGGER_GPIO_PIN`来配置。默认值为PTA18引脚。

- 要选择触发数据包测试并启用测试菜单，请按[5]键。
- 要开始触发数据包测试，请按[空格键]。等待大约4ms，它将显示接收到的数据包。
- 要返回测试菜单，请按[回车键]。

3.3.6 接收模式测试

此测试用例允许测量Rx接收器，如图11所示。在这种模式下，它启用Rx连续接收。

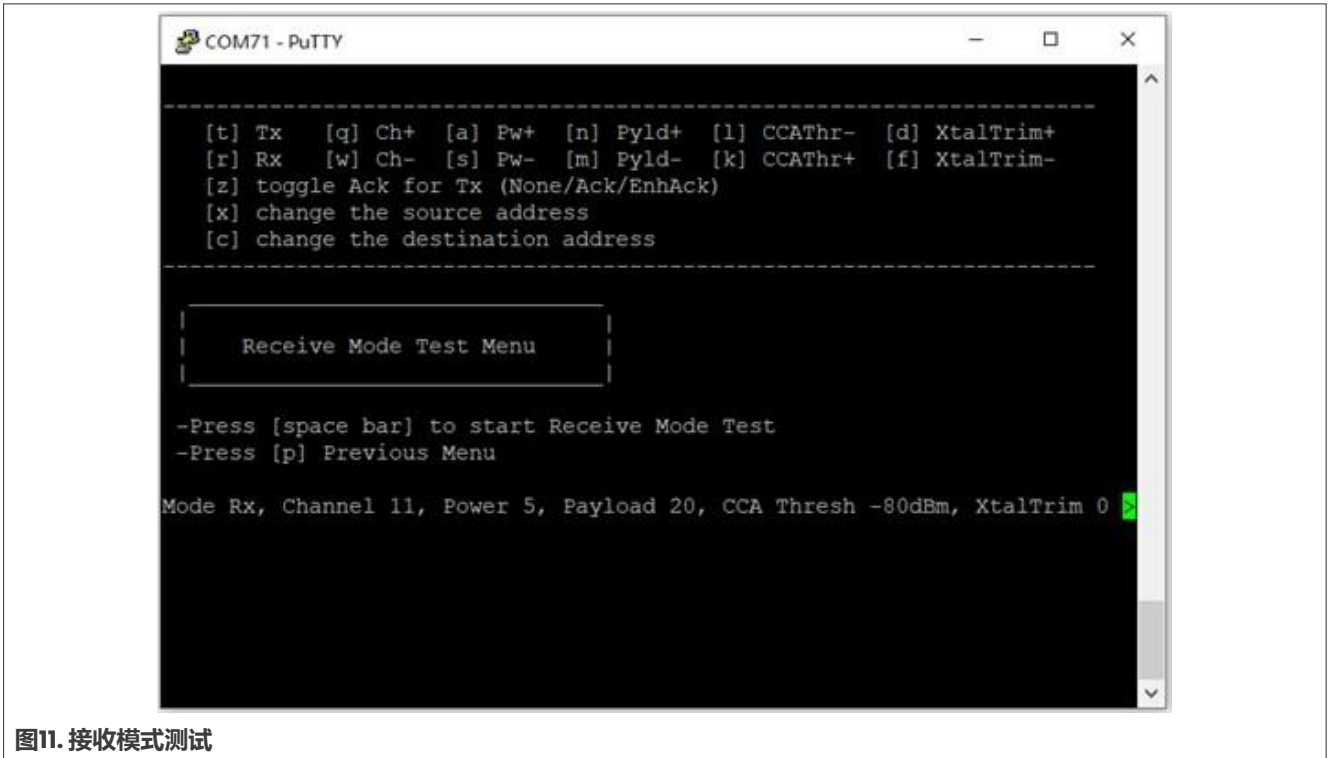


图11. 接收模式测试

要选择接收模式测试并启用测试菜单，请按[6]键。

- 要开始接收数据包并启用接收模式，请按[空格键]。
- 要停止接收数据包模式并显示已接收到的数据包数量，请再次按[空格键]。
- 要返回测试菜单，请按[回车键]。

3.3.7 Tx/Rx切换测试

Rx转Tx和Tx转Rx的切换测试是802.15.4物理层要求的一部分。

• Rx转Tx:

将设备的RFIO端口连接到射频信号发生器。射频信号发生器被配置为向设备传输一个符合标准的信号和数据包（具有任意有效载荷和正确的CRC）。要选择“Rx转Tx切换”和“Tx转Rx切换”测试并启用测试菜单，请按[7]键。

– 要启用Rx/Tx切换测试，请通过选项[r]选择**Rx**模式。

– 要开始接收数据包，请按[空格键]。

设备处于接收模式并等待数据包。每次接收到一个数据包时，设备都会发送一个确认信息。可以使用频谱分析仪监测射频信号，并测量接收到的数据包结束与发送的ACK开始之间的延迟。

• Tx转Rx:

将设备的RFIO端口连接到射频信号发生器，并将设备的一个GPIO（默认为PTD1）连接到射频信号发生器的外部触发输入端。配置射频信号发生器，以便在外部触发信号请求时发送一个确认信号。

要选择“Rx转Tx切换”和“Tx转Rx切换”测试并启用测试菜单，请按[7]键。

– 要启用Tx/Rx切换测试，请通过选项[r]选择**Tx**模式。

– 要开始接收数据包，请按[空格键]。

设备发送一个数据包，并在数据包结束时在PTD1上生成一个负触发信号。在收到触发信号后，信号发生器会发送一个ACK消息。从触发开始到设备发送ACK的实际开始之间的延迟就是可测量的Tx转Rx的切换时间。窗口中将显示一条确认消息，且设备停止发送。

4 修订历史

[表2](#)汇总了本文的修订情况。

表2. 修订历史

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